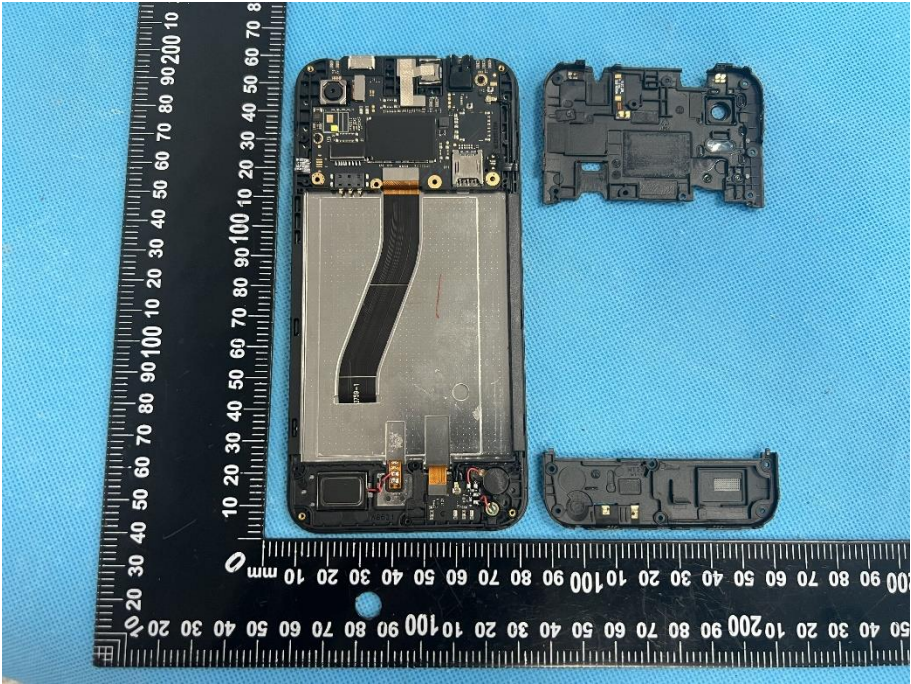
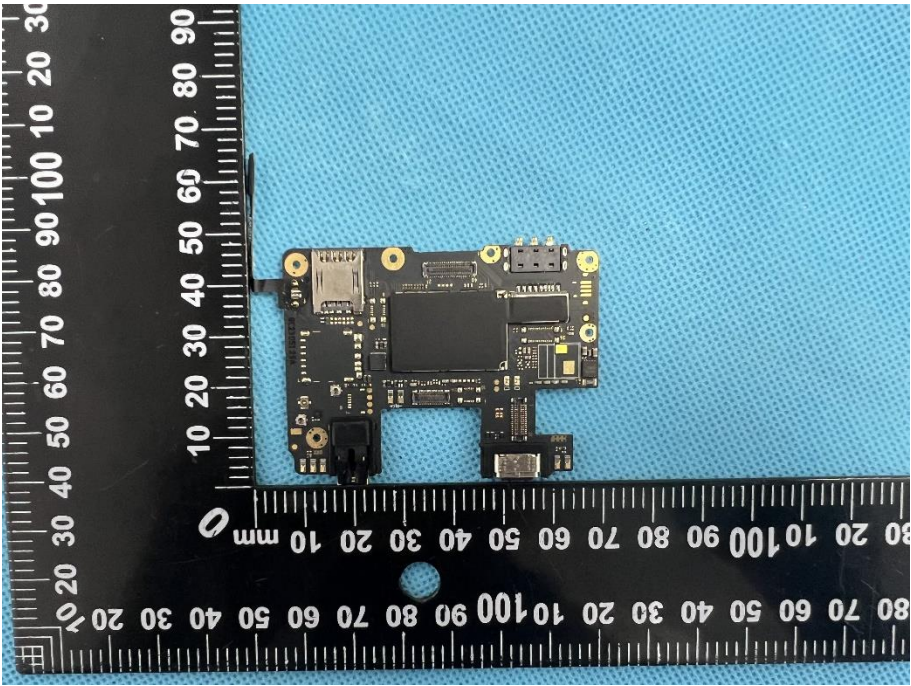
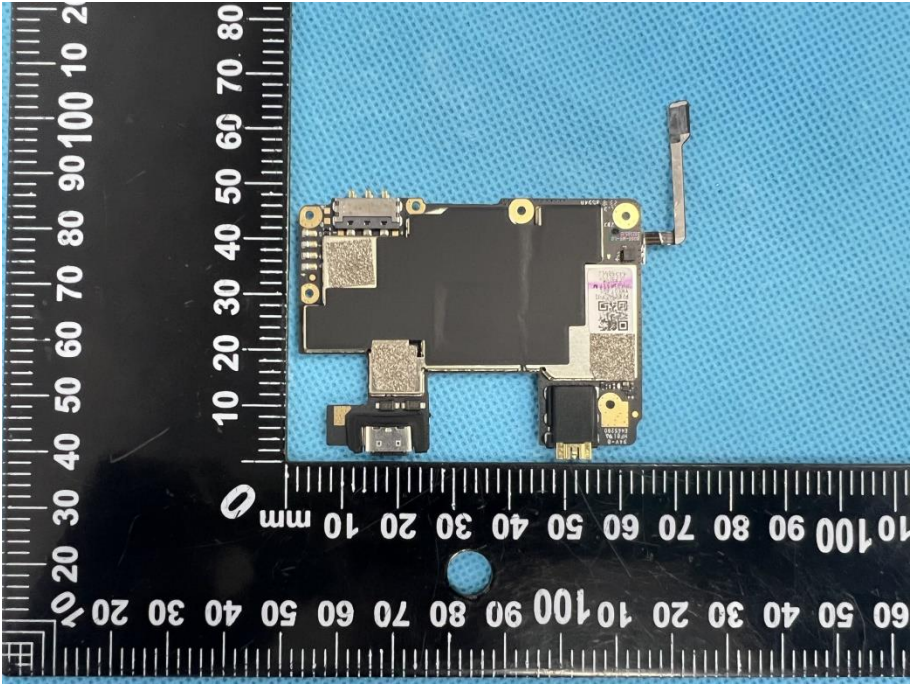
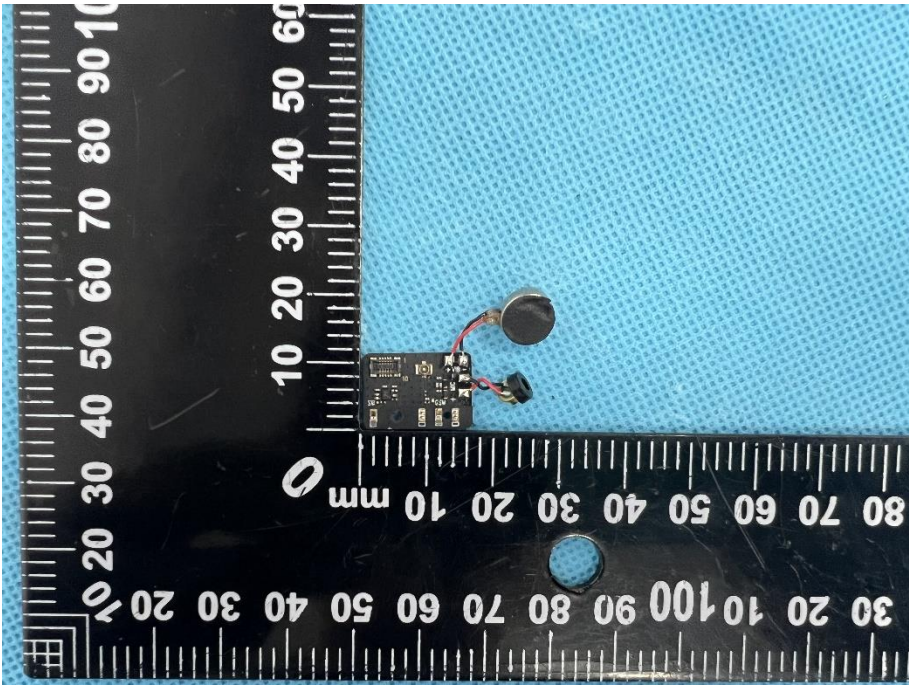
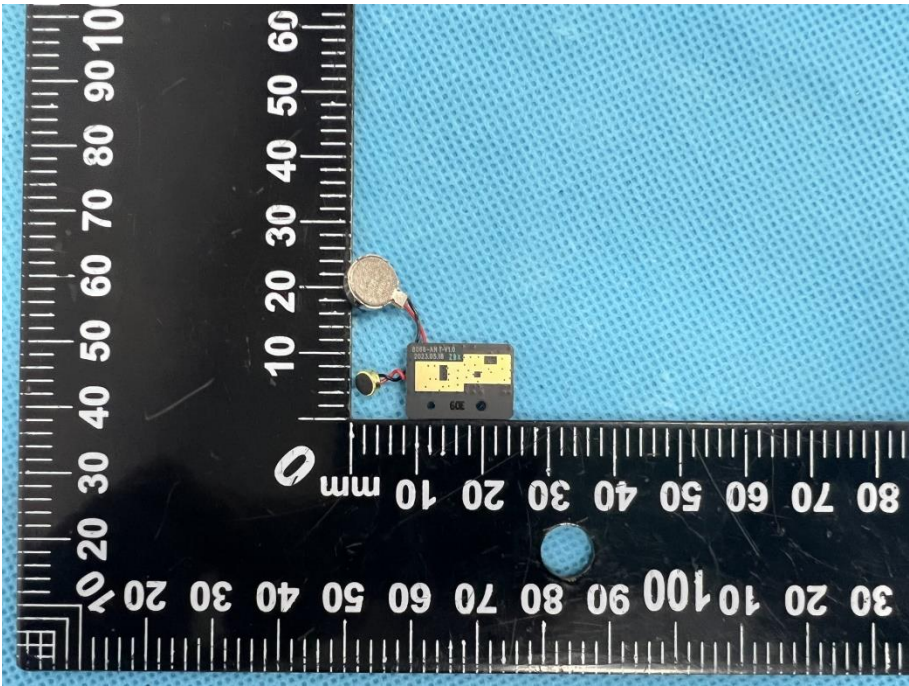


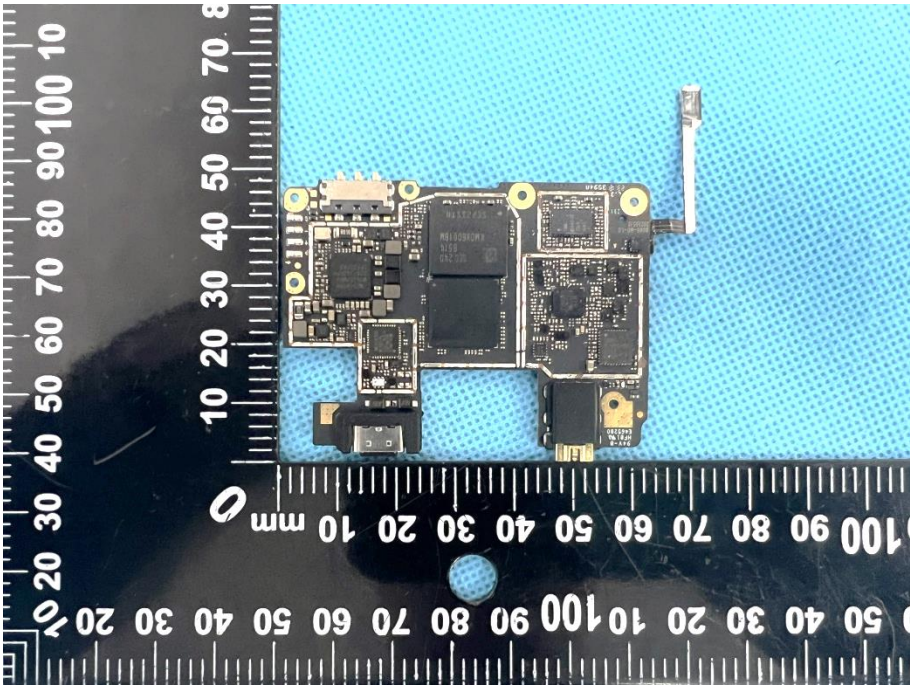
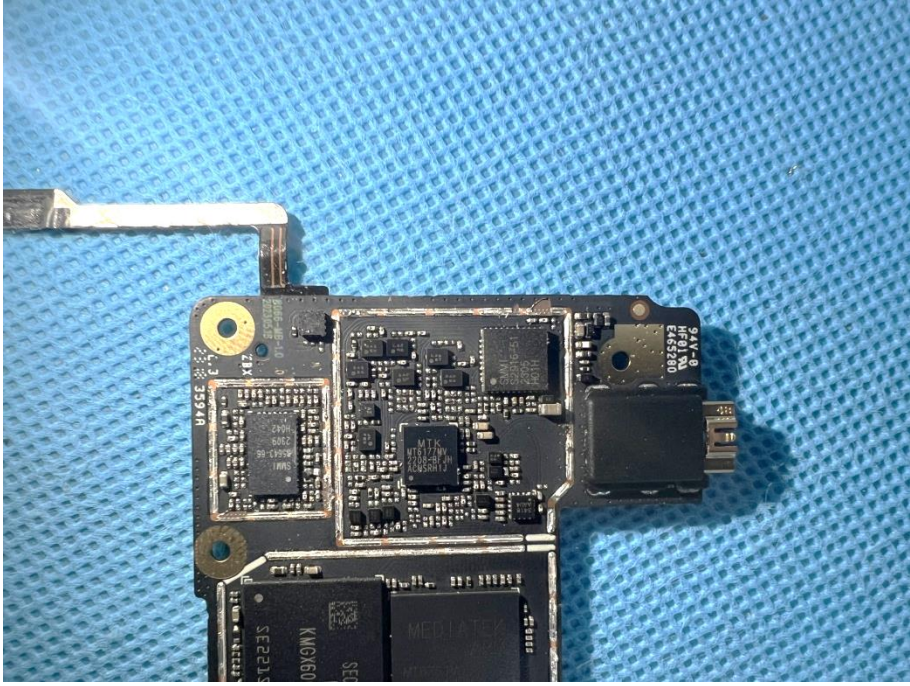
EXHIBIT 3 - EUT INTERNAL PHOTOGRAPHS

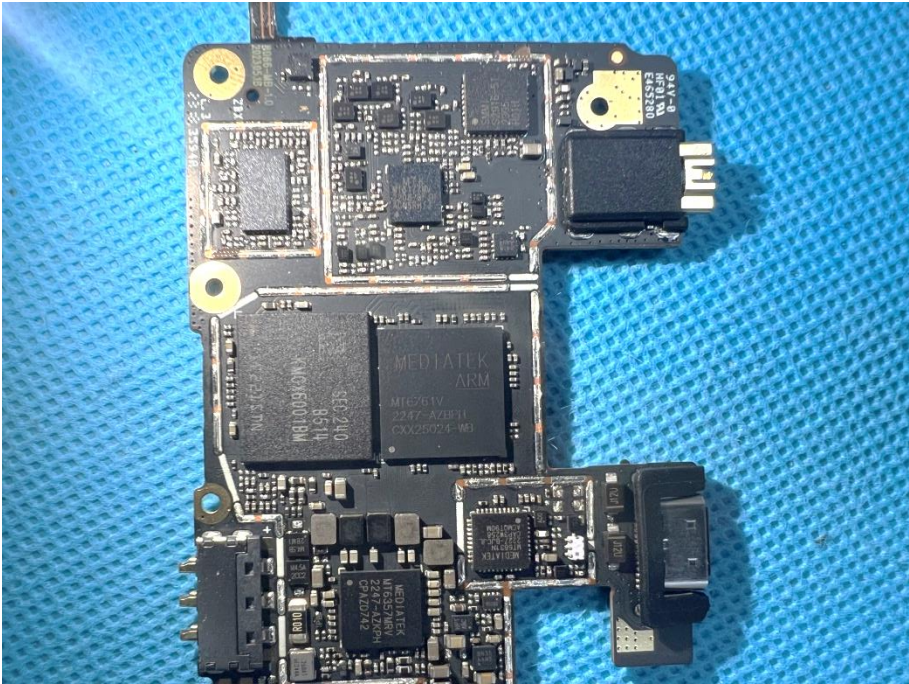
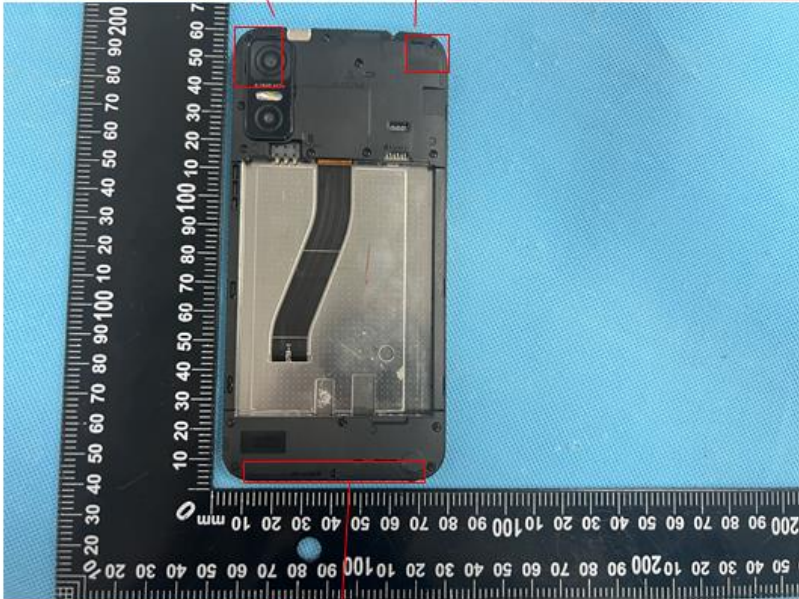
EUT Housing and Board View 1	 A photograph showing the internal components of a mobile phone, specifically the housing and the main board. The components are laid out on a blue surface next to a black ruler with white markings. The ruler is oriented vertically, with the 0 mark at the top. The housing is on the left, and the main board is on the right. The main board has the text "NTVIC" printed on it. The housing has a camera lens and a flash visible at the top.
EUT Housing and Board View 2	 A photograph showing the internal components of a mobile phone, specifically the housing and the main board. The components are laid out on a blue surface next to a black ruler with white markings. The ruler is oriented vertically, with the 0 mark at the top. The housing is on the left, and the main board is on the right. The main board has the text "NTVIC" printed on it. The housing has a camera lens and a flash visible at the top.

EUT Housing and Board View 3	 A photograph showing the back of a mobile phone with its housing removed, revealing the internal battery and camera module. A black ruler with white markings is placed vertically to the left of the phone for scale. The background is a blue textured surface.
EUT Housing and Board View 4	 A photograph showing the front of a mobile phone with its housing removed, revealing the internal circuit board and components. Two separate pieces of the phone's housing are placed to the right of the phone. A black ruler with white markings is placed vertically to the left of the phone for scale. The background is a blue textured surface.

Solder Board-Component View 1	 A photograph of a small, rectangular electronic component, likely a solder board, placed on a blue textured surface. The component is dark green with various electronic components, including a large black chip, several smaller chips, and numerous surface-mount components. It is positioned next to a black ruler with white markings, which shows dimensions in millimeters. The ruler is oriented vertically, with the component's length corresponding to the 0 to 100 mm scale.
Solder Board-Component View 2	 A photograph of the same electronic component from a different angle, showing the underside. The component is dark green with various electronic components, including a large black chip, several smaller chips, and numerous surface-mount components. It is positioned next to a black ruler with white markings, which shows dimensions in millimeters. The ruler is oriented vertically, with the component's length corresponding to the 0 to 100 mm scale.

Solder Board-Component View 3	 A photograph showing a small electronic component, likely a microcontroller or sensor, mounted on a blue solder mask. The component is connected to a circular pad on the board. A black ruler with white markings is placed below the component for scale. The ruler shows measurements in millimeters (0 to 100 mm) and centimeters (0 to 10 cm).
Solder Board-Component View 4	 A photograph showing the same electronic component from a different angle. The component is mounted on a blue solder mask. A circular pad is visible on the board. A black ruler with white markings is placed below the component for scale. The ruler shows measurements in millimeters (0 to 100 mm) and centimeters (0 to 10 cm).

Solder Board-Component View 5	 A photograph of a small electronic circuit board (PCB) with various components, including a large central chip and several smaller components. The board is placed on a blue textured surface. A black ruler with white markings is positioned horizontally below the board, showing measurements in millimeters. The ruler has markings from 0 to 100 mm on the left side and 0 to 100 mm on the right side.
Solder Board-Component View 6	 A photograph of the same electronic circuit board (PCB) from a different angle. The board is placed on a blue textured surface. The components are more clearly visible, including a large central chip, a smaller chip to the left, and a connector on the right. The board is oriented vertically.

Solder Board-Component View 7	 A photograph of a mobile phone's internal circuit board (PCBA) laid flat on a blue textured surface. The board is populated with various electronic components, including a large MediaTek ARM processor chip in the center, several memory chips, and various passive components like capacitors and resistors. Two yellow circular markers are placed on the left side of the board. A black antenna module is visible on the right side.
Antenna View	 A photograph showing the back of a mobile phone with its antenna components. A black ruler is placed vertically on the left side of the phone for scale. Three red boxes with leader lines point to specific antenna locations: one at the top left, one at the top right, and one at the bottom center. Each box contains text describing the supported communication standards and frequency bands for that antenna. WIFI/BT/GPS Ant GSM1900; WCDMA Band 2/ 4; LTE Band 2/4/66Ant. GSM850; WCDMA Band 5; LTE Band 5/12/71 Ant.